Integrated, Step-Down Switching Regulator with PMBus

General Description

The MAX20743 is a fully integrated, highly efficient switching regulator with PMBus™ for applications operating from 4.5V to 16V and requiring up to 35A maximum load. This single-chip regulator provides extremely compact, high-efficiency power delivery solutions with high-precision output voltages and excellent transient response for networking, datacom and telecom equipment.

The IC offers a broad range of programmable features through either the PMBus or through a capacitor and resistor connected to a dedicated programming pin. Using this feature, the operation can be optimized for a specific application, reducing the component count and/ or setting appropriate trade-offs between the regulator's performance and system cost. Ease of programming enables using the same design for multiple applications.

The IC includes protection and telemetry features. Positive and negative cycle-by-cycle overcurrent protection and overtemperature protection ensure a rugged design. Input undervoltage lockout shuts down the device to prevent operation when the input voltage is out of specification. A status pin provides an output signal to show that the output voltage is within range and the system is regulating.

Applications

- Communication Equipment
- Networking Equipment
- Servers and Storage Equipment
- Point-of-Load Voltage Regulators
- µP Chipset
- Memory V_{DDQ}
- I/O

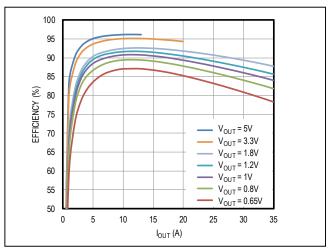
DESCRIPTION	CURRENT RATING*	INPUT VOLTAGE	OUTPUT VOLTAGE
Electrical Rating	35A	4.5V to 16V	0.6V to 5.5V
Thermal Rating T _A = 55°C, 200LFM	34A	12V	1V
Thermal Rating T _A = 85°C, 0LFM	22A	12V	1V

*For specific operating conditions, refer to the SOA curves in the Typical Operating Characteristics section.

Benefits and Features

- High-Power Density and Low Component Count
 - Overall Solution Size 509mm² Including Inductor and Output Capacitors
 - 90.8% Peak Efficiency with V_{DDH} = 12V and V_{OUT} = 1V
 - Fast Transient Response: Supports Up to 300A/µs Load-Step Transients
- Optimized Component Performance and Efficiency with Reduced Design-In Time
 - PMBus-Compliant Interface for Telemetry and Power Management
 - Voltage, Current and Temperature Reporting through Digital Bus
- Increased Power-Supply Reliability with System and IC Self-Protection Features
 - Differential Remote Sense with Open-Circuit Detection
 - · Hiccup Overcurrent Protection
 - · Programmable Thermal Shutdown

Typical System Efficiency vs. Load Current (V_{DDH} = 12V)



Ordering Information appears at end of data sheet.

PMBus is a trademark of SMIF, Inc.



Integrated, Step-Down Switching Regulator with PMBus

Absolute Maximum Ratings

Input Pin Voltage (V _{DDH}) (Note 1)0.3V to +18V	Switching Node Voltage (VX) DC0.3V to +18V
V _{CC} 0.3V to +2V	Switching Node Voltage (VX) 25ns (Note 2)10V to +23V
STAT, OE, CLK, DATA, and	(BST - VX) Pin Differential0.3V to +2.5V
SMALERT Pin Voltages0.3V to +4V	Junction Temperature (T _J)+150°C
PGMA, PGMB, V _{SENSE+} and	Storage Temperature Range65°C to +150°C
V _{SENSE-} Pin Voltages0.3V to +2V	Peak Reflow Temperature Lead-Free+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Operating Ratings

Input Voltage (V _{DDH})4.5V to 16V	Maximum Average Input Current (I _{VDDH}) (Note 3)6A
Junction Temperature (T _J)40°C to +125°C	Maximum Average Output Current (I _{OUT})35A
	Peak Output Current (Ipk)60A

Package Information

PACKAGE CODE	P154A8F+1		
Outline Number	<u>21-100031</u>		
Land Pattern Number	90-100022		
THERMAL RESISTANCE, FOUR-LAYER BOARD			
Junction to Ambient (θ _{JA})	13°C/W		
Junction to Case (θ _{JC}) (Still Air, No Heatsink; Note 4)	0.47°C/W		

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

- Note 1: As measured at the V_{DDH} pin referenced to the GND pin immediatly adjacent using a high-frequency scope probe with I_{LOAD} at I_{MAX}. A high-frequency input bypass capacitor must be located less than 60 mils from the V_{DDH} pin per our design guidelines.
- Note 2: The 25ns rating is the allowable voltage on the VX node in excess of the -0.3V to +18V DC ratings. The VX voltage can exceed the DC rating in either the positive or negative direction for up to 25ns per cycle.
- Note 3: See the Average Input Current Limit section.
- Note 4: Data taken using the MAX20743 evaluation kit (MAX20743EVKIT#). The PCB has 4 layers of 2oz copper.

Electrical Characteristics

(Circuit of Figure 6, V_{DDH} = 4.5V to 16V, T_A = +32°C, unless otherwise noted. Typical values are at T_A = +32°C. All devices 100% tested at room temperature. Limits over temperature guaranteed by design.)

PARAMETER	SYMBOL	CON	IDITIONS	MIN	TYP	MAX	UNITS	
SUPPLY VOLTAGE	,			,				
Supply Voltage Range	V _{DDH}	T _J = -40°C to +125°C		4.5		16	V	
OUTPUT VOLTAGE (Note 5)								
Output-Voltage Range	V _{OUT}	(Note 6)		0.6		5.5	V	
		Default is 1mV/µs;	other values are set		1			
Slew Rate when V _{OUT} is Changed through PMBus		through PMBus; me	easured at V _{SENSE+/-}		2		mV/μs	
Changed throught i Mbas		pins		4				
V _{REF}								
					0.6484			
V _{BOOT} Values		Selected by C_SEL	A (Note 7)		0.8984		V	
					1.0			
	V _{REF}	Referred to	0.6484V V _{REF}	-1.2		+1.2		
V _{REF} Tolerance	* KEF	V _{SENSE+/-} pins	0.8984V V _{REF}	-1.0		+1.0	%	
		(Notes 6, 8)	1V V _{REF}	-1.0		+1.0		
Values Available through PMBus Command		See Table 8 for accuracy vs. V _{REF} (Note 7)		0.6016		1.0	V	
FEEDBACK LOOP								
Integrator Recovery Time Constant	t _{REC}				20		μs	
				0.72	0.9	1.1		
Gain (see the Control Loop section for details)	R _{GAIN}	Selected by R_SEL (Notes 6, 7, 8, 9)	B or PMBus	1.4	1.8	2.2	mV/A	
section for details)		(Notes 0, 7, 0, 9)		2.9	3.6	4.4		
SWITCHING FREQUENCY								
					400			
					500			
Switching Frequency			0kHz selected by C_s are set through PMBus		600		kHz	
Switching Frequency	f _{SW}	(Note 7)	are set tillought inbus		700			
				800				
					900			
Switching Frequency Accuracy		(Notes 6, 8, 9)		-15		+15	%	
INPUT PROTECTION								
V _{DDH} UVLO Threshold (Rising)		(Note 6)			4.25	4.47	V	
V _{DDH} UVLO Threshold (Falling)	V _{DDH_UVLO}	(1.0.0 0)		3.75	3.9			
Hysteresis					350		mV	

Electrical Characteristics (continued) (Circuit of Figure 6, V_{DDH} = 4.5V to 16V, T_A = +32°C, unless otherwise noted. Typical values are at T_A = +32°C. All devices 100% tested at room temperature. Limits over temperature guaranteed by design.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
OUTPUT-VOLTAGE PROTECTION	N (OVP)						
Overvoltage-Protection Threshold (Rising)	OVP	Relative to programmed V _{OUT}		10	13	16	%
OVP Deglitch Filter Time					8		μs
Power-Good Protection Threshold (Falling)		Relative to programm	ed V _{OUT}	6	9	12	%
Power-Good Protection Threshold (Rising)	PWRGD			3	6	9	%
Power-Good Deglitch Filter Time					8		μs
OVERCURRENT PROTECTION (OCP)						
			OCP Setting 0	11.8	18.9	26.0	
Positive OCP Inception Threshold (Inductor Valley		Selected by R_SELB or PMBus	OCP Setting 1	16.0	24.1	32.2	
Current)		or PMBus (Notes 6, 7, 8, 9)	OCP Setting 2	19.8	29.2	38.6	A
			OCP Setting 3	24.5	34.1	43.8	
	OCP		OCP Setting 0		-26.4		
Negative OCP Inception Threshold (Inductor Valley		Selected by R_SELB	OCP Setting 1		-31.3		
Current)		or PMBus	OCP Setting 2		-36.0		A
			OCP Setting 3		-40.8		
Hysteresis		Hysteresis applies on	ly to positive OCP		20		%
OVERTEMPERATURE PROTECT	ION (OTP)						
OTP Inception Threshold			Default is 150°C; 130°C is set through		130	140	
o i moophen imeened	OTP	PMBus (Notes 7, 8, 9)	140	150	160	°C
Hysteresis					10		
OE MAXIMUM VOLTAGE	T	T		1			T.
OE Maximum Voltage		Full V _{CC} supply range	e measured at the			3.6	
Rising Threshold	OE	OE pin; keep OE ≤ V _E 3.6V (Note 6)		0.83	0.9	0.97	V
Hysteresis	JE	, ,			0.2		
OE Pin Input Resistance				200	275	350	kΩ
OE Deglitch Filter Time		(Note 9)		0.9		2.2	μs

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Electrical Characteristics (continued) (Circuit of Figure 6, V_{DDH} = 4.5V to 16V, T_A = +32°C, unless otherwise noted. Typical values are at T_A = +32°C. All devices 100% tested at room temperature. Limits over temperature guaranteed by design.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
STARTUP TIMING							
Enable Time from OE Rise to Start of BST Charge	t _{OE}	After t _{INIT}		16		μs	
				0.75			
O. f. Olad Barra Tire		3ms or 1.5ms can be bet by R_SELA; any		1.5			
Soft-Start Ramp Time	t _{SS}	value can be set by PMBus (Note 7)		3		ms	
				6			
BST Charging Time	t _{BST}			8		μs	
STAT PIN							
Pullup Voltage	VOH _{STAT}				3.6	V	
		I _{STAT} = 2.5mA			0.4		
Status Output Low	VOL _{STAT}	I_{STAT} = 0.2mA, 0V < V_{CC} < UVLO and 0V < V_{DDH} < UVLO (Note 6)			0.65	v	
		I _{STAT} = 1.3mA, 0V < V _{CC} < UVLO and 0V < V _{DDH} < UVLO (Note 6)			0.75		
Status Output High Leakage Current	I _{STAT}	STAT pulled up to 3.3V through 20kΩ (Note 6)			7	μА	
Time from V _{OUT} Ramp Completion to STAT Pin Released	[†] STAT	STAT output low to high, default is 125; 2000 can be set through PMBus (Note 7)		125		μs	
				2000			
PGMA AND PGMB PINS (see Tab	les 2–5)						
Allowable R_SEL Resistor Range		12 resistor values detected	1.78		162	kΩ	
R_SEL Resistor Required Accuracy		EIA standard resistor values only		±1		%	
Allowable C_SEL Capacitor Range		3 options (0pF, 220pF, or 1000pF)	0		1000	pF	
C_SEL Capacitor Required Accuracy		Use X7R or better		±20		%	
Allowable External Capacitance		Load and stray capacitance in addition to C_SELA/B			20	pF	
PMBus TELEMETRY			,				
Reading Range			4.5		16	V	
Reading Update Interval				5		ms	
Reading Averaging Interval	V _{DDH} Readback			1		ms	
Reading Error	i veaupack	$T_A = -40^{\circ}\text{C to } T_J = 125^{\circ}\text{C (Notes 8, 9, 10)}$	-3		+3	%	
Reading Resolution				28		mV	

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Electrical Characteristics (continued)

(Circuit of Figure 6, V_{DDH} = 4.5V to 16V, T_A = +32°C, unless otherwise noted. Typical values are at T_A = +32°C. All devices 100% tested at room temperature. Limits over temperature guaranteed by design.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Reading Range			0		1.25	V
Reading Update Interval				5		ms
Reading Averaging Interval				1		ms
Reading Error Referred to SENSE Pins (V _{OUT} can be scaled by divider in feedback)	V _{SENSE} Readback	$T_A = -40$ °C to $T_J = +125$ °C (Notes 8, 9, 10)	-25		+25	mV
Reading Resolution				1.95		mV
Reading Range			0		35	Α
Reading Update Interval				5		ms
Reading Averaging Interval	I _{OUT} Readback			1		ms
Reading Error	Readback	$T_A = -40^{\circ}C \text{ to } T_J = +125^{\circ}C \text{ (Notes 8, 9, 10)}$		±3		Α
Reading Resolution				0.07		Α
Reading Range			-40		+125	°C
Reading Update Interval]			5		ms
Reading Averaging Interval	Temperature Readback			1		ms
Reading Error] Troudbuok	(Notes 6, 8, 9)		±8		ů
Reading Resolution				0.52		ů
PMBus PINS (CLK, DATA, SMALI	ERT)					
Input Rising Threshold	V _{T_RISE}		0.83	0.9	0.97	V
Input Falling Threshold	V _{T_FALL}		0.62	0.7	0.79	V
Hysteresis	V _{HYS}			0.2		V
Output Low Voltage	V _{OL}	Sinking 4mA			0.4	V
PMBus Clock Frequency	f _{PM_CLK}				400	kHz
SYSTEM SPECIFICATIONS (Note	11)					
Line Regulation	V			±0.2		%
Load Regulation (Static)	V _{OUT}	I _{OUT} = 0 - I _{MAX}		±0.7		70
Efficiency (V _{DDH} = 12V,	n	Peak		90.8		%
V _{OUT} = 1V)	η	Full load (35A)		84		70

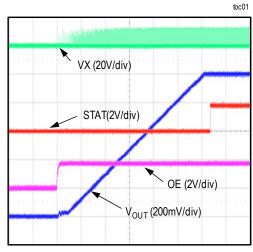
- Note 5: For proper regulation, it is required that V_{DDH} > (V_{OUT} + 2V). If V_{OUT} is set > (UVLO 2V), the IC can come out of UVLO, but regulation is not guaranteed while V_{DDH} is below (V_{OUT} + 2V). To avoid this condition, OE can be held low until V_{DDH} > (V_{OUT} + 2V).
- **Note 6:** Denotes specifications that apply over the temperature range of $T_J = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$.
- Note 7: Denotes parameters that are programmable.
- **Note 8:** Min/max limits are $\geq 4\sigma$ about the mean.
- Note 9: Guaranteed by design; not production tested.
- Note 10:A -40°C test condition is specified at a TA test condition, instead of TJ to allow for self heating.
- Note 11: These specifications refer to the operation of the system and are based on the circuit shown in the reference schematic.

 Tolerance of external components can affect these parameters. System performance numbers are measured using the Maxim evaluation board for this product with BOM as shown in the MAX20743 EV kit data sheet. If a different PCB layout and different external components are used, these values can change.

Typical Operating Characteristics

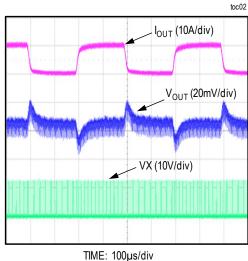
(Unless otherwise stated: Tested on the MAX20743EVKIT# EV kit with component values per $\frac{\text{Table 7}}{\text{Table 7}}$, V_{DDH} = 12V, V_{OUT} = 1V, f_{SW} = 400kHz, T_A = +25°C, Still Air, and No Heatsink.)

STARTUP RESPONSE



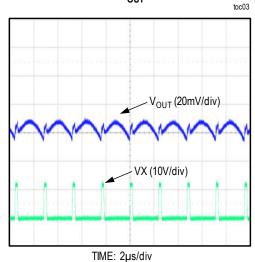
TIME: 500µs/div

TRANSIENT RESPONSE



CONDITIONS: I_{OUT} = 20A to 30A STEP at 1A/ μ s

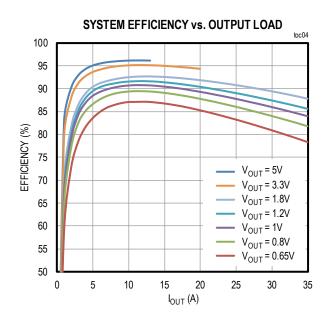
TYPICAL V_{OUT} RIPPLE

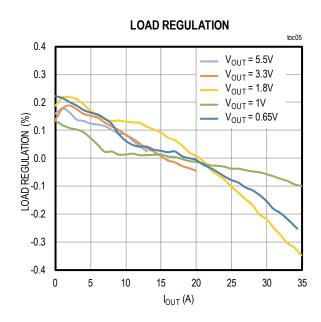


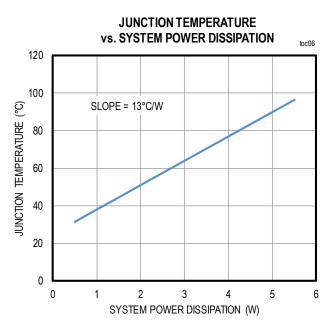
CONDITIONS: I_{OUT} = 35A

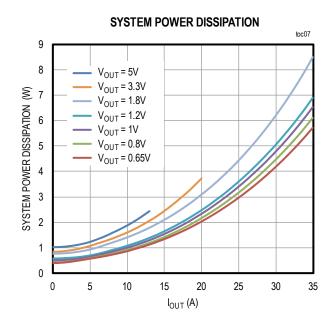
Typical Operating Characteristics (continued)

(Unless otherwise stated: Tested on the MAX20743EVKIT# EV kit with component values per $\frac{\text{Table 7}}{\text{NDDH}}$ = 12V, $\frac{\text{$



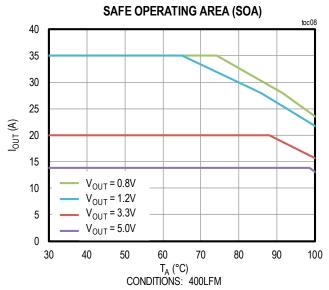




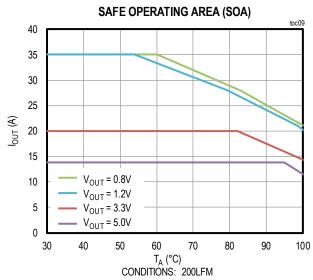


Typical Operating Characteristics (continued)

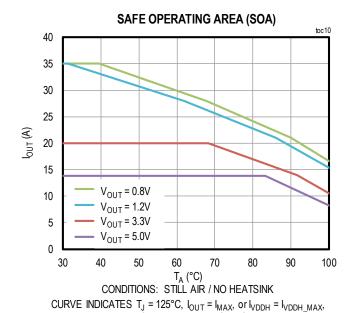
(Unless otherwise stated: Tested on the MAX20743EVKIT# EV kit with component values per $\frac{\text{Table 7}}{\text{NDDH}}$ = 12V, $\frac{\text{$



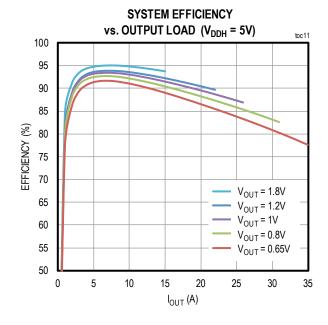
CURVE INDICATES T_J = 125°C, $I_{OUT} = I_{MAX}$, or $I_{VDDH} = I_{VDDH_MAX}$, WHICHEVER HAPPENS FIRST



CURVE INDICATES T_J = 125°C, $I_{OUT} = I_{MAX}$, or $I_{VDDH} = I_{VDDH_MAX}$, WHICHEVER HAPPENS FIRST

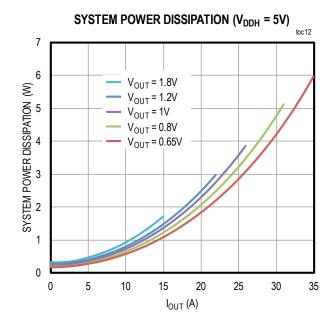


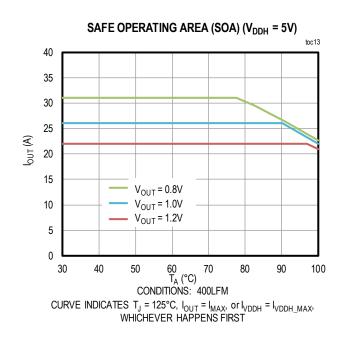
WHICHEVER HAPPENS FIRST

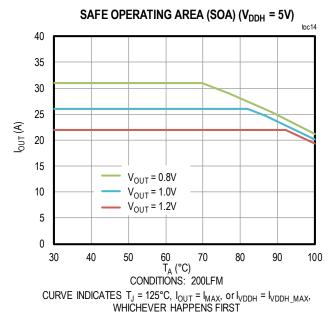


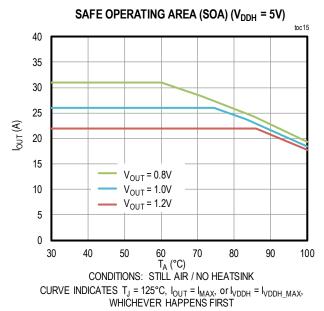
Typical Operating Characteristics (continued)

(Unless otherwise stated: Tested on the MAX20743EVKIT# EV kit with component values per $\frac{\text{Table 7}}{\text{NDDH}}$ = 12V, $\frac{\text{$

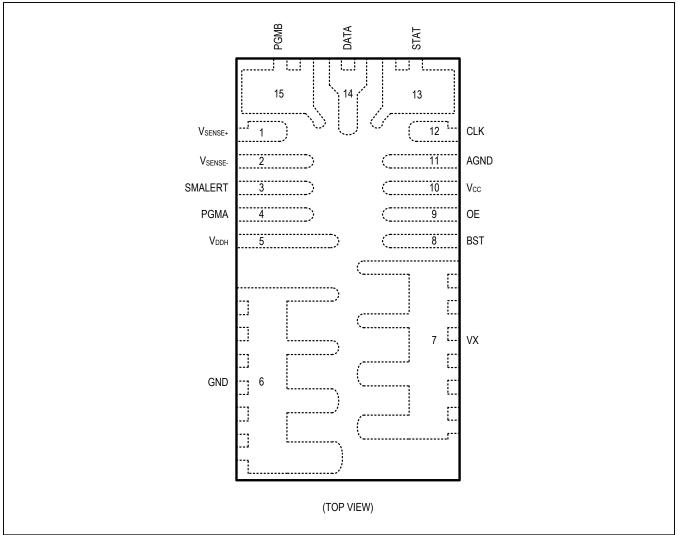








Pin Configuration

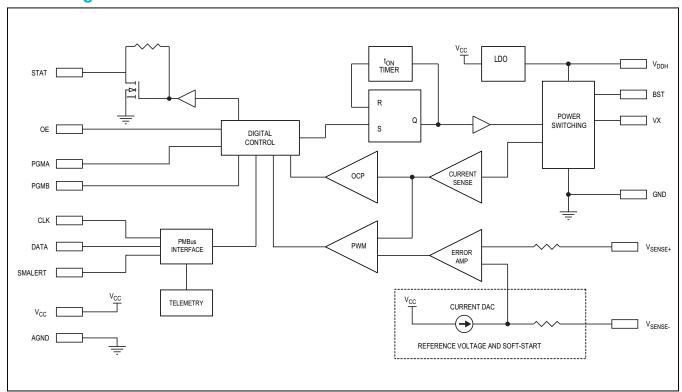


Integrated, Step-Down Switching Regulator with PMBus

Pin Description

PIN	NAME	FUNCTION
1	V _{SENSE+}	Remote-Sense Positive Node. Connect this node to V _{OUT} at the load. A resistive voltage divider can be used to regulate the output above the reference voltage.
2	V _{SENSE} -	Remote-Sense Negative Node. Connect this node to ground at the load using a Kelvin connection.
3	SMALERT	SMALERT Pin
4	PGMA	Program Node. Connect this node to ground through a programming resistor and capacitor.
5	V _{DDH}	Power Input Voltage. The high-side MOSFET switch is connected to this node. See the <i>Input Capacitor</i> section for decoupling requirements.
6	GND	Power Ground Node. The low-side MOSFET switch is connected to this node.
7	VX	Power Switching Node. Connect this node to the inductor.
8	BST	Bootstrap for High-Side Switch. Connect a 0.22µF ceramic capacitor between BST and VX.
9	OE	Output-Enable Node. This node is used to enable the regulator and has a precise threshold to allow sequencing of multiple regulators. There is an internal $275k\Omega$ (typ) pulldown on this pin.
10	Vcc	Analog/Gate-Drive Supply for the IC from Internal 1.85V (typ) LDO. This node must be connected to three 10µF X5R or better decoupling capacitors with a very short, wide trace. V_{CC} can be connected to 20k Ω pullups for STAT and OE as shown in Figure 6. Do not connect V_{CC} to other external loads. Do not overdrive V_{CC} from an external source.
11	AGND	Analog/Signal Ground. See the PCB Layout section for layout information.
12	CLK	PMBus Clock
13	STAT	Open-Drain Power-Good/Fault-Status Indication. Connect a pullup resistor to 1.8V or 3.3V.
14	DATA	PMBus Data
15	PGMB	Program Node. Connect this node to ground through a programming resistor and capacitor.

Block Diagram



Operation

Control Architecture

The MAX20743 provides an extremely compact, highefficiency regulator solution with minimal external components and circuit design required. The monolithic solution includes the top and bottom power switches, gate drives, precision DAC reference, PWM controller, fault protections, and PMBus interface (see the <u>Block Diagram</u>).

An external bootstrap capacitor is used to provide the drive voltage for the top switch. Other external components include the input and output filter capacitors, buck inductor, and a few resistors and capacitors to set the operating mode.

The IC implements an advanced valley currentmode control algorithm that supports all multi-layer ceramic chip (MLCC) output capacitors and fast transient response. In steady-state, it operates at a fixed switching frequency. When a positive load step is applied to the output, the switching frequency speeds up to minimize the output voltage undershoot. Similarly, when the load step is removed, the switching frequency slows down to minimize the output voltage overshoot.

The switching frequency can be set to 400kHz, 600kHz, or 800kHz through C_SELB and can be overridden through PMBus to 400kHz, 500kHz, 600kHz, 700kHz, 800kHz, or 900kHz.

Voltage regulation is achieved by modulating the low-side on-time, comparing the difference between the feedback and reference voltages with the low-side current-sense signal using Maxim's proprietary integrated current-sense technology. Once the PWM modulator forces a low-to-high transition, the high-side switch is enabled for a fixed time, after which the low-side switch is turned on again. An error amplifier with an integrator is used to maintain zero-droop operation. The integrator has a transient recovery time constant of 20µs (typ).

During regulation, the differential voltage between the V_{SENSE+} and V_{SENSE-} pins tracks the reference voltage, which is set by the DAC and can be set from 0.6016V to 1V. The sense pins can be connected to the output voltage through a voltage-divider, so V_{OUT} can be higher than 1V

The switching frequency is determined by the high-side on-time, as shown in Equation 1.

Equation 1:

$$f_{SW} = \frac{1}{t_{H_ON}} \times \frac{V_{OUT}}{V_{DDH}}$$

where:

f_{SW} = Switching frequency (MHz)

 $t_{H ON}$ = On-period for high-side switch (μ s)

V_{OUT} = Output voltage (V)

V_{DDH} = Input voltage (V).

The t_{H_ON} high-side on-time is controlled by the IC to be proportional to the duty cycle so that the resulting switching frequency is independent of supply voltage and output voltage.

Equation 2:

$$t_{H_ON} \propto \frac{V_{OUT}}{V_{DDH}}$$

The t_{H_ON} pulse width is clamped to a minimum of 50ns (after t_{SS}) and a maximum of 2 μ s to prevent any unexpected operation during extreme V_{OLT} conditions.

Voltage-Regulator Enable and Turn-On Sequencing

The startup timing is shown in Figure 1. After V_{DDH} is applied, the IC goes through an initialization time (t_{INIT}) that takes up to 308µs. After initialization, OE is read. Once OE is high for more than the 16µs OE filter time (t_{OE}) , BST charging starts and is performed for 8µs (t_{BST}) , after which the soft-start ramp begins. The soft-start ramp time (t_{SS}) can be 0.75ms, 1.5ms, 3ms, or 6ms depending on the user's programmed value. V_{OUT} ramps up linearly during the soft-start ramp time. If there are no faults, the STAT pin can transition high after the completion of the soft-start ramp time, plus the STAT blanking time (t_{STAT}) . t_{STAT} is programmable with options of 125µs and 2ms. If OE is pulled low, the IC shuts down.

Alternatively, the IC can be enabled by sending a PMBus Operate command. This raises the internal Operate signal that is OR'd with the OE pin to create an internal OE signal. Therefore, when either the OE pin or the internal Operate signal goes high, startup is initiated, but it takes both to be low to shut the part down.

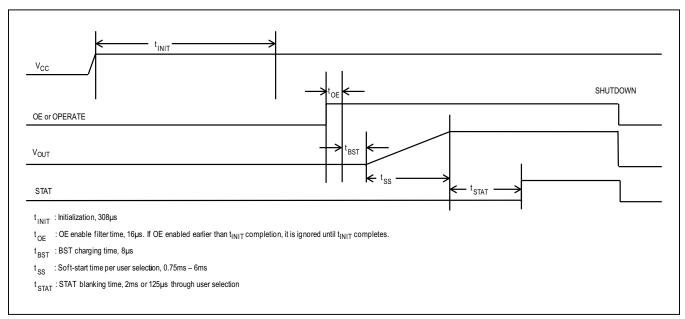


Figure 1. Startup Timing

Soft-Start Control

The initial output voltage behavior is determined by a linear ramp of the internal reference voltage from zero to the final value (t_{SS} in Figure 1). The ramp time (t_{SS}) is programmable from 0.75ms to 6ms.

If the regulator is enabled when the output voltage has a residual voltage, the system does not regulate until the reference voltage ramps above this residual value. In this case, the t_{OE} (OE valid to onset of regulation) specification is extended by the time required for the desired voltage startup ramp to reach the actual residual output voltage, but the time to reach the steady-state output voltage is unchanged.

If the residual voltage is higher than the set output voltage, neither the high-side or low-side switch is turned on by the end of t_{SS} . Under these conditions, switching begins after t_{SS} .

The MAX20743 exhibits a 400mV (typ) non-linearity during startup when R_{GAIN} is set to 1.8mV/A or 3.6mV/A. This behavior is normal and does not have an adverse effect on system operation. For best startup linearity, an R_{GAIN} of 0.9mV/A is recommended. See Startup Response in *Typical Operating Characteristics*.

Remote Output-Voltage Sensing

To ensure accurate sensing of the output voltage, a differential voltage-sense topology is used, with a negative remote-sense pin provided. Point-of-load (PoL) sensing compensates for voltage drops between the output of the regulator and its load and provides the highest regulation accuracy. The voltage-sensing circuit features excellent common-mode rejection to further improve load voltage regulation.

Protection and Status Operation

Output-Voltage Protection

The feedback voltage is continuously monitored for both undervoltage and overvoltage conditions. The typical fault-detection threshold is 13% above and 9% below the reference voltage (see the *Electrical Characteristics* table). If the output voltage falls below the power-good protection (PWRGD) threshold beyond the filter time, the STAT output goes low but the system continues to operate, attempting to maintain regulation.

If the output voltage rises above the overvoltageprotection (OVP) threshold beyond the filter time, the STAT pin is lowered and the system shuts down until the output voltage falls within the valid range.

Current-Limiting and Short-Circuit Protection

The regulator's valley current-mode control architecture provides inherent current limiting and short-circuit protection. The bottom switch's instantaneous current is monitored using integrated current sensing and is controlled on a cycle-by-cycle basis within the control block.

Current clamping occurs when the minimum instantaneous ("valley") low-side switch current level exceeds the OCP threshold current, as shown in Figure 2. In this situation, turn-on of the high-side switch is prevented until the current falls below the threshold level. Since the inductor valley current is the controlled parameter, the average current delivered during positive current clamping remains a function of several system-level parameters. Note that $I_{\rm OCP}$ has hysteresis and the value drops down to $I_{\rm OCP2}$ once it has been triggered, as shown in Figure 2.

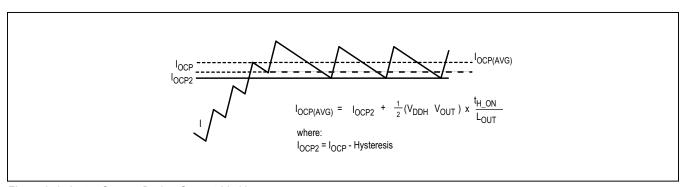


Figure 2. Inductor Current During Current Limiting

Undervoltage Lockout (UVLO)

The regulator internally monitors V_{DDH} with a UVLO circuit. When the input supply voltage is below the UVLO threshold, the regulator stops switching, and the STAT pin is driven low. For UVLO levels, see the *Electrical Characteristics* table.

Overtemperature Protection (OTP)

The OTP-level default is 150°C and can be set to 130°C over PMBus. If the die temperature reaches the OTP level during operation, the regulator is disabled and the STAT pin is driven low. Overtemperature is a nonlatching fault, with the hysteresis shown in the *Electrical Characteristics* table.

Table 1. Summary of Fault Actions

FAULT	ACTION
Power good (output undervoltage)	STAT low
Output OVP	STAT low, shut down and restart
Overtemperature	STAT low, shut down and restart
Supply fault (VDDH_UVLO; VCC_UVLO)	STAT low, shut down and restart
BST fault	STAT low, shut down and restart

Table 2. PGMA Pin R_SELA Values

NO.	R (kΩ) ±1%	SOFT-START TIME (mS)	PMBus SLAVE ADDRESS (1010_xxx)
1	1.78	3	1010 000b
2	2.67	3	1010 001b
3	4.02	3	1010 010b
4	6.04	3	1010 011b
5	9.09	3	1010 100b
6	13.3	3	1010 101b
7	20	3	1010 110b
8	30.9	3	1010 111b
9	46.4	1.5	1010 000b
10	71.5	1.5	1010 001b
11	107	1.5	1010 010b
12	162	1.5	1010 011b

Regulator Status (STAT)

The STAT signal provides an open-drain output, consistent with CMOS logic levels, which indicates whether the regulator is functioning properly. An external pullup resistor is required for connecting STAT to V_{CC} or another 1.8V or 3.3V supply.

The STAT pin is low while the regulator is disabled and goes high after the startup ramp is completed, plus the programmed t_{STAT} blanking interval if the output voltage is within the PWRGD/OVP regulation window. The STAT pin is an open-drain output and is 3.3V tolerant. The pin remains low when V_{DDH} is not present.

Table 3. PGMA Pin C_SELA Capacitor Values

NO.	C (pF) ±20%	V _{BOOT} (V)
1	Open	0.6484
2	220	0.8984
3	1000	1

Table 4. PGMB Pin R SELB Values

NO.	R (kΩ) ±1%	R _{GAIN} (mΩ)	OCP (A)
1	1.78	3.6	20
2	2.67	3.6	25
3	4.02	3.6	30
4	6.04	3.6	35
5	9.09	1.8	20
6	13.3	1.8	25
7	20	1.8	30
8	30.9	1.8	35
9	46.4	0.9	20
10	71.5	0.9	25
11	107	0.9	30
12	162	0.9	35

Table 5. PGMB Pin C_SELB Capacitor Values

NO.	C (pF) ±20%	f _{SW} FREQUENCY (kHz)
1	Open	400
2	220	600
3	1000	800

Integrated, Step-Down Switching Regulator with PMBus

The STAT pin is driven low when one or more of the following conditions exists:

- PWRGD fault (see the <u>Output-Voltage Protection</u> section).
- V_{SENSE} pin is left unconnected or shorted to V_{DDH}.
- Die temperature exceeds the temperature shutdown threshold shown in the *Electrical Characteristics* table.
- OVP circuit detects that the output voltage is above the tolerance limit.
- Supply voltage drops below the UVLO threshold.
- Fault is detected on the BST node, such as a shorted or open bootstrap capacitor.

The ensuing startup follows the same timing shown in Figure 1.

PGMA and **PGMB** Pin Functionality

The PGMA and PGMB pins are used to set up some of the key programmable features of the regulator IC. A

resistor and capacitor are connected to the PGMA/B pins and their values are read during power-up initialization. Power must be cycled to re-read the values.

PMBus Commands

A summary of PMBus commands is shown in <u>Table 6</u>. For more information, refer to AN6042: *MAX20743 PMBus Application Note*.

PMBus Telemetry

The IC provides input voltage, output voltage, output current, and junction temperature telemetry. Output voltage is measured at the V_{SENSE+/-} pins; therefore, if there is a divider in the feedback, the measurement is scaled by the divide ratio. For range and accuracy specifications, see the *Electrical Characteristics* table. For data format, refer to AN6042: *MAX20743 PMBus Application Note*.

Table 6. PMBus Command List

COMMAND CODE	COMMAND NAME	TYPE	NO. OF DATA BYTES
01h	OPERATION	RW	1
02h	ON_OFF_CONFIG	RO	1
03h	CLEAR_FAULTS	wo	0
10h	WRITE_PROTECT	RW	1
1Bh	PMBALERT_MASK	RW	2
20h	VOUT_MODE	RO	1
21h	VOUT_COMMAND	RW	2
24h	VOUT_MAX	RW	2
78h	STATUS_BYTE	RO	1
79h	STATUS_WORD	RO	2
7Ah	STATUS_VOUT	RO	1
7Bh	STATUS_IOUT	RO	1
7Ch	STATUS_INPUT	RO	1

COMMAND	COMMAND NAME	TYPE	NO. OF DATA BYTES
7Dh	STATUS_TEMPERATURE	RO	1
7Eh	STATUS_CML	RO	1
80h	STATUS_MFR_SPECIFIC	RO	1
88h	READ_VIN	RO	2
8Bh	READ_VOUT	RO	2
8Ch	READ_IOUT	RO	2
8Dh	READ_TEMPERATURE_1	RO	2
99h	MFR_ID	BLK	4
9Bh	MFR_REVISION	BLK	1
D1h	MFR_VOUT_MIN	RW	2
D2h	MFR_DEVSET1	RW	2
D3h	MFR_DEVSET2	RW	2

Note: RW = Read/Write, WO = Write Only, RO = Read Only, and BLK = Block.

Reference Design

A typical application schematic is shown in <u>Figure 3</u>, while <u>Table 7</u> shows optimum component values for common output voltages.

Average Input Current Limit

The input current of V_{DDH} is given by Equation 3. V_{OUT} , I_{OUT} , and V_{DDH} should be properly chosen so that the average input current does not exceed 6A ($I_{VDDH\ MAX}$).

Equation 3:

$$I_{VDDH} = \frac{V_{OUT} \times I_{OUT}}{V_{DDH} \times \eta}$$

where:

V_{OUT} = Output Voltage

I_{OUT} = Output Current

V_{DDH} = Input Voltage

 η = Efficiency (refer to the <u>Typical Operating Characteristics</u> section.)

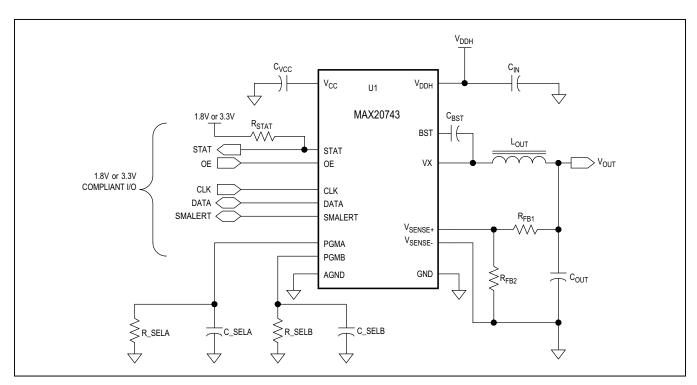


Figure 3: Typical Application Circuit

Table 7. Reference Design Component Values

V _{OUT} (V)	R _{FB1} (kΩ)	R _{FB2} (kΩ)	R_SELA (kΩ)	C_SELA (pF)	R_SELB (kΩ)	C_SELB (pF)	R _{GAIN} (mΩ)	V _{REF} (V)	f _{SW} (kHz)	L _{OUT} (nH)	c _{out}
0.6484	1	Open	1.78	Open	162	Open	0.9	0.6484	400	170	6 x 100μF + 2 x 470μF
0.8	1.37	5.9	1.78	Open	162	Open	0.9	0.6484	400	170	6 x 100μF + 2 x 470μF
1	1.87	3.48	1.78	Open	162	Open	0.9	0.6484	400	170	6 x 100μF + 2 x 470μF
1.2	1.74	2.05	1.78	Open	162	Open	0.9	0.6484	400	170	6 x 100μF + 2 x 470μF
1.8	3.09	1.74	1.78	Open	162	220	0.9	0.6484	600	170	6 x 100μF + 2 x 470μF
3.3	5.62	1.37	1.78	Open	71.5	220	0.9	0.6484	600	210	6 x 100μF + 2 x 470μF
5.0	7.15	1.07	1.78	Open	71.5	220	0.9	0.6484	600	210	6 x 100μF + 2 x 470μF

Output-Voltage Setting

If an output voltage not listed in $\underline{\text{Table }7}$ is required, calculate new values for R_{FB1} and R_{FB2} (as discussed below) and use the other circuit values of the closest output voltage in Table 7, or calculate them as shown below.

The output voltage is set by the V_{REF} DAC and divider ratio of resistors R_{FB1} and R_{FB2} per Equation 4. The IC regulates the V_{SENSE+} pin to the reference voltage (V_{REF}), which is set by the DAC. Upon power-up, the DAC voltage initializes to one of the user-selectable V_{BOOT} voltages. Using PMBus, the DAC can also be set to any voltage from 0.6016V to 1V with 3.9mV resolution, as shown in Table 8. The divider resistors are chosen to give the correct output voltage and to have an approximate parallel resistance of R_{PAR} = 1k Ω for best commonmode rejection of the error amplifier. In applications requiring less than 10mV peak-to-peak output voltage ripple, setting a lower DAC reference voltage such as 0.6484V or less is recommended because the part will have less DAC voltage noise.

Equation 4:

$$V_{OUT} = V_{REF} x \left(1 + \frac{R_{FB1}}{R_{FB2}} \right)$$

where $V_{REF} = 0.6016V$ to 1V (set by DAC).

The divider resistors are then given by Equation 5.

Equation 5:

$$R_{FB1} = V_{OUT} x \left(\frac{R_{PAR}}{V_{REF}} \right)$$

$$R_{FB2} = R_{FB1} x \left(\frac{R_{PAR}}{R_{FB1} - R_{PAR}} \right)$$

where:

R_{FB1} = Top divider resistor

R_{FB2} = Bottom divider resistor

 R_{PAR} = Desired parallel resistance of R_{FB1} and R_{FB2}

V_{OUT} = Output voltage

V_{RFF} = Reference voltage = 0.6016V to 1V (set by DAC).

Table 8. Voltage vs. PMBus VOUT COMMAND

VOUT COMMAND [9:0] (decimal)	VOLTAGE (V)	ACCURACY (+/-)
307	0.6016	1.3%
308	0.6016	1.3%
309	0.6055	1.3%
310	0.6055	1.3%
311	0.6094	1.3%
312	0.6094	1.3%
313	0.6133	1.3%
314	0.6133	1.3%
315	0.6172	1.3%
316	0.6172	1.3%
317	0.6211	1.3%
318	0.6211	1.3%
319	0.6250	1.3%
320	0.6250	1.3%
321	0.6289	1.2%
322	0.6289	1.2%
323	0.6328	1.2%

VOUT COMMAND [9:0] (decimal)	VOLTAGE (V)	ACCURACY (+/-)
324	0.6328	1.2%
325	0.6367	1.2%
326	0.6367	1.2%
327	0.6406	1.2%
328	0.6406	1.2%
329	0.6445	1.2%
330	0.6445	1.2%
331	0.6484	1.2%
332	0.6484	1.2%
333	0.6523	1.2%
334	0.6523	1.2%
335	0.6563	1.2%
336	0.6563	1.2%
337	0.6602	1.2%
338	0.6602	1.2%
339	0.6641	1.2%
340	0.6641	1.2%

VOUT COMMAND [9:0] (decimal)	VOLTAGE (V)	ACCURACY (+/-)
341	0.6680	1.2%
342	0.6680	1.2%
343	0.6719	1.2%
344	0.6719	1.2%
345	0.6758	1.2%
346	0.6758	1.2%
347	0.6797	1.2%
348	0.6797	1.2%
349	0.6836	1.2%
350	0.6836	1.2%
351	0.6875	1.1%
352	0.6875	1.1%
353	0.6914	1.1%
354	0.6914	1.1%
355	0.6953	1.1%
356	0.6953	1.1%
357	0.6992	1.1%

Table 8. Voltage vs. PMBus VOUT_COMMAND (continued)

		· · · · · · · · · · · · · · · · · · ·
VOUT COMMAND [9:0] (decimal)	VOLTAGE (V)	ACCURACY (+/-)
358	0.6992	1.1%
359	0.7031	1.1%
360	0.7031	1.1%
361	0.7070	1.1%
362	0.7070	1.1%
363	0.7109	1.1%
364	0.7109	1.1%
365	0.7148	1.1%
366	0.7148	1.1%
367	0.7188	1.1%
368	0.7188	1.1%
369	0.7227	1.1%
370	0.7227	1.1%
371	0.7266	1.1%
372	0.7266	1.1%
373	0.7305	1.1%
374	0.7305	1.1%
375	0.7344	1.1%
376	0.7344	1.1%
377	0.7383	1.1%
378	0.7383	1.1%
379	0.7422	1.1%
380	0.7422	1.1%
381	0.7461	1.1%
382	0.7461	1.1%
383	0.7500	1.1%
384	0.7500	1.1%
385	0.7539	1.1%
386	0.7539	1.1%
387	0.7578	1.1%
388	0.7578	1.1%
389	0.7617	1.1%
390	0.7617	1.1%
391	0.7656	1.0%
392	0.7656	1.0%
	-	

VOUT COMMAND [9:0] (decimal)	VOLTAGE (V)	ACCURACY (+/-)
393	0.7695	1.0%
394	0.7695	1.0%
395	0.7734	1.0%
396	0.7734	1.0%
397	0.7773	1.0%
398	0.7773	1.0%
399	0.7813	1.0%
400	0.7813	1.0%
401	0.7852	1.0%
402	0.7852	1.0%
403	0.7891	1.0%
404	0.7891	1.0%
405	0.7930	1.0%
406	0.7930	1.0%
407	0.7969	1.0%
408	0.7969	1.0%
409	0.8008	1.0%
410	0.8008	1.0%
411	0.8047	1.0%
412	0.8047	1.0%
413	0.8086	1.0%
414	0.8086	1.0%
415	0.8125	1.0%
416	0.8125	1.0%
417	0.8164	1.0%
418	0.8164	1.0%
419	0.8203	1.0%
420	0.8203	1.0%
421	0.8242	1.0%
422	0.8242	1.0%
423	0.8281	1.0%
424	0.8281	1.0%
425	0.8320	1.0%
426	0.8320	1.0%
427	0.8359	1.0%

VOUT COMMAND [9:0] (decimal)	VOLTAGE (V)	ACCURACY (+/-)
428	0.8359	1.0%
429	0.8398	1.0%
430	0.8398	1.0%
431	0.8438	1.0%
432	0.8438	1.0%
433	0.8477	1.0%
434	0.8477	1.0%
435	0.8516	1.0%
436	0.8516	1.0%
437	0.8555	1.0%
438	0.8555	1.0%
439	0.8594	1.0%
440	0.8594	1.0%
441	0.8633	1.0%
442	0.8633	1.0%
443	0.8672	1.0%
444	0.8672	1.0%
445	0.8711	1.0%
446	0.8711	1.0%
447	0.8750	1.0%
448	0.8750	1.0%
449	0.8789	1.0%
450	0.8789	1.0%
451	0.8828	1.0%
452	0.8828	1.0%
453	0.8867	1.0%
454	0.8867	1.0%
455	0.8906	1.0%
456	0.8906	1.0%
457	0.8945	1.0%
458	0.8945	1.0%
459	0.8984	1.0%
460	0.8984	1.0%
461	0.9023	1.0%
462	0.9023	1.0%

Table 8. Voltage vs. PMBus VOUT_COMMAND (continued)

VOUT COMMAND [9:0] (decimal)	VOLTAGE (V)	ACCURACY (+/-)
463	0.9063	1.0%
464	0.9063	1.0%
465	0.9102	1.0%
466	0.9102	1.0%
467	0.9141	1.0%
468	0.9141	1.0%
469	0.9180	1.0%
470	0.9180	1.0%
471	0.9219	1.0%
472	0.9219	1.0%
473	0.9258	1.0%
474	0.9258	1.0%
475	0.9297	1.0%
476	0.9297	1.0%
477	0.9336	1.0%
478	0.9336	1.0%
479	0.9375	1.0%

VOUT COMMAND [9:0] (decimal)	VOLTAGE (V)	ACCURACY (+/-)
480	0.9375	1.0%
481	0.9414	1.0%
482	0.9414	1.0%
483	0.9453	1.0%
484	0.9453	1.0%
485	0.9492	1.0%
486	0.9492	1.0%
487	0.9531	1.0%
488	0.9531	1.0%
489	0.9570	1.0%
490	0.9570	1.0%
491	0.9609	1.0%
492	0.9609	1.0%
493	0.9648	1.0%
494	0.9648	1.0%
495	0.9688	1.0%
496	0.9688	1.0%

VOUT COMMAND [9:0] (decimal)	VOLTAGE (V)	ACCURACY (+/-)
497	0.9727	1.0%
498	0.9727	1.0%
499	0.9766	1.0%
500	0.9766	1.0%
501	0.9805	1.0%
502	0.9805	1.0%
503	0.9844	1.0%
504	0.9844	1.0%
505	0.9883	1.0%
506	0.9883	1.0%
507	0.9922	1.0%
508	0.9922	1.0%
509	0.9961	1.0%
510	0.9961	1.0%
511	1.0000	1.0%
512	1.0000	1.0%
_	_	_

Note: The repeated voltage values in the table are due to ignoring the LSB in hardware. The available V_{BOOT} values are highlighted in gray. Voltages shown are referenced to the sense pins. Actual V_{OUT} can be scaled by a voltage-divider in the feedback.

Control-Loop Stability

The IC uses valley current-mode control which is stabilized by selecting appropriate values of C_{OUT} and R_{GAIN} . No compensation network is required. For stability, the loop bandwidth (BW) should be 100kHz or less. Consider the case of using MLCC output capacitors that have nearly ideal impedance characteristics in the frequency range of interest with negligible ESR and ESL. The loop bandwidth can be approximated by breaking the loop into gain terms as outlined below.

The voltage-loop gain consists of the following terms:

- 1) The IC's valley current-mode control scheme has an effective transconductance gain of 1/R_{GAIN}.
- 2) For MLCC capacitors, the output capacitors contribute an impedance gain of $1/(2 \times \pi \times C_{OUT} \times f)$.
- The feedback-divider contributes an attenuation of K_{DIV} = R_{FB2}/(R_{FB1} + R_{FB2}).
- 4) An inherent high-frequency pole located at 150kHz independent of switching frequency.

When the BW is 100kHz or less, the high-frequency pole can be ignored and the approximate loop gain and BW are given by Equation 6.

Equation 6:

$$\begin{split} \left| \text{LOOP_GAIN}(f) \right| &= \frac{K_{DIV}}{2 \text{ x } \pi \text{ x R}_{GAIN} \text{ x C}_{OUT} \text{ x f}} \\ BW &= \frac{K_{DIV}}{2 \text{ x } \pi \text{ x R}_{GAIN} \text{ x C}_{OUT}} \end{split}$$
 OR
$$BW &= \frac{1}{2 \text{ x } \pi \text{ x R}_{GAIN} \text{ EFF x C}_{OUT}}$$

where:

RGAIN EFF = RGAIN/KDIV.

For stability, R_{GAIN} and C_{OUT} should be chosen so that BW < 100 kHz.

The available R_{GAIN} settings are shown in <u>Table 4</u>. When choosing which R_{GAIN} setting to use, one should consider that while higher R_{GAIN} allows the loop to be stabilized with less C_{OUT} ; less C_{OUT} generally results in higher ripple and larger transient overshoot and undershoot, so there needs to be a balance.

Integrator

The IC has an integrator included in its error amplifier that was ignored in the above equations for simplicity. The integrator only adds gain at low frequencies, so it does not

significantly affect the loop BW calculation. The purpose of the integrator is to improve load regulation. The integrator adds a factor of $(1/t_{REC} + s)/s$ to the loop gain.

Step Response

R_{GAIN_EFF} is important since it determines the small-signal transient response of the regulator. When a load step is applied that does not exceed the slew-rate capability of the inductor current, the regulator responds linearly and V_{OUT} temporarily changes by the amount of V_{OUT ERROR} (Equation 7).

Equation 7:

The integrator causes V_{OUT} to recover to the nominal value with a time constant of t_{REC} = 20µs. The regulator can be modeled to a first-order by the averaged small-signal equivalent circuit shown in Figure 4. Here, V_{EQ} is an ideal voltage source, R_{EQ} is an equivalent lossless resistance created by the control-loop action, and L_{EQ} is an equivalent inductance. Note that L_{EQ} is not the same as the actual L_{OUT} inductor that has been absorbed into the model. C_{OUT} is the actual output capacitance.

Output-Capacitor ESR

The preceding control-loop discussion considered the use of MLCC output capacitors. Another application worth mentioning is the use of output

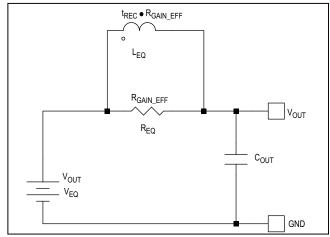


Figure 4. Averaged Small-Signal Equivalent Circuit of Regulator

Note: The large-signal transient response is approximately the larger between the V_{OUT_ERROR} and the Unloading Transient (see Equation 16).

Integrated, Step-Down Switching Regulator with PMBus

capacitors with more significant ESR. This can be considered as long as the capacitors are rated to handle the inductor current ripple and expected surge currents. Thus far, it has been assumed that C_{OUT} is comprised of MLCCs and the net ESR is negligible compared to R_{GAIN}/K_{DIV} . If the net ESR of the C_{OUT} bank is not negligible compared to R_{GAIN}/K_{DIV} , the inductor current ripple is effectively sensed by the ESR and adds to the R_{GAIN} EFF, as shown in Equation 8.

Equation 8:

$$R_{GAIN_EFF} = \frac{R_{GAIN}}{\kappa_{DIV}} + ESR$$

The capacitor's ESR also introduces a zero into the loop gain. The inherent high-frequency pole helps to compensate this zero. For a more in-depth view of the effect of circuit values on regulator performance, the Maxim Simplis model and the MAX20743 evaluation kit can be used. It is recommended to simulate and/or test regulator performance when using values other than the recommended component values.

The performance data shown in the *Typical Operating Characteristics* section was taken using the MAX20743 evaluation kit and component values in <u>Table 7</u>. For most applications, these are the optimum values to use. <u>Table 9</u>, <u>Table 10</u>, and <u>Table 11</u> show suitable part numbers for input and output capacitors and the inductor.

Table 9. Recommended Inductors

COMPANY	VALUE (nH)	I _{SAT} (A)	R _{DC} (mΩ)	FOOTPRINT (mm)	HEIGHT (mm)	PART NUMBER	WEBSITE
Cooper	170	60	0.29	10.4 x 8.0	7.5	FP1007R3-R17-R	www.cooperindustries.com
Pulse	210	64	0.32	13.5 x 13.0	8.0	PA0513.211NLT	www.pulseelectronics.com
Pulse	260	55	0.32	13.5 x 13.0	8.0	PA0513.261NLT	www.pulseelectronics.com
Pulse	320	45	0.32	13.5 x 13.0	8.0	PA0513.321NLT	www.pulseelectronics.com
Pulse	440	30	0.32	13.5 x 13.0	8.0	PA0513.441NLT	www.pulseelectronics.com

Table 10. MLCC Input Capacitors

CASE SIZE	VALUE (μF)	TEMPERATURE RATING	VOLTAGE RATING	T (Note 1) (mm)	COMPANY	PART NUMBER
0603	1	X7S X7R	16V	0.8 (Note 2)	Murata TDK	GRM188C71C105KA12D C1608X7R1C105K
0805	2.2	X7R	25V 16V 16V	1.25 1.25 1.25	Murata TDK AVX	GRM21BR71E225KA73L C2012X7R1C225M 0805YC225MAT
0805	4.7	X7R	16V	1.25	Murata	GRM21BR71C475K
1206	4.7	X7R	16V	1.65	AVX Murata	1206YC475MAT GRM31CR71C475KA01L
1206	10	X7R	16V	1.65	Murata TDK AVX	GRM31CR71C106KAC7L C3216X7R1C106M 1206YC106MAT
1210	10	X7R	16V 25V	2.0 2.5	Murata TDK	GRM32DR71C106KA01L C3225X7R1E106M
1210	22	X7R	16V	2.45 2.5 2.5	AVX Murata TDK	1210YC226MAT GRM32ER71A476K C3225X7R1C226M

Note 1: T indicates nominal thickness.

Note 2: Indicates capacitors with nominal thickness smaller than the minimum FCQFN package thickness.

Table 11. Recommended Output Capacitors

COMPANY	VALUE (MF)	PART NUMBER	TEMP. RATING	VOLT. RATING	CASE SIZE	T (NOTE 1) (mm)	WEBSITE
AVX	22	08054D226MAT2A	X5R	4V	0805	1.3	MANA SVACORD COM
AVA	22	12066D226MAT2A	X5R	6.3V	1206	1.65	www.avxcorp.com
	22	GRM21BR60J226ME39L	X5R	6.3V	0805	1.25	
Murata	22	GRM31CR60J226KE19L	X5R	6.3V	1206	1.6	www.murata.co.jp
	22	GRM32DR60J226KA01L	X5R	6.3V	1210	2.0	
	22	ECJ3YB0J226M	X5R	6.3V	1206	1.6	
Panasonic	22	ECJHVB0J226M	X5R	6.3V	1206	0.85	www.panasonic.com
22	ECJ3Y70J226M	X7R	6.3V	1206	1.65		
	22	ANNICOTOR IOCONTO INNICOTOR IOCONT	X5R	4V	0805	1.25	
Taiyo Yuden 22 22	AMK212BJ226MG JMK316BJ226ML	X5R	6.3V	1206	1.6	www.taiyo-yuden.com	
	JMK325BJ226MY	X5R	6.3V	1210	1.9		
	22	C2012X5R0J226M	X5R	6.3V	0805	1.25	
TDK	, 22	C3216X5R0J226M	X5R	6.3V	1206	1.6	
TDK 22	22	C3225X5R0J226M	X5R	6.3V	1210	1.6	www.component.tdk.com
	22	C3216X6S0J226M	X6S	6.3V	1206	1.6	

Note 1: T indicates nominal thickness.

Inductor Selection

The output inductor has an important influence on the overall size, cost, and efficiency of the voltage regulator. Since the inductor is typically one of the larger components in the system, a minimum inductor value is particularly important in space-constrained applications. Smaller inductor values also permit faster transient response, reducing the amount of output cap needed to maintain transient tolerances.

For any buck regulator, the maximum current slew rate through the output inductor is given by Equation 9.

Equation 9:

$$SlewRate = \frac{dI_L}{dt} = \frac{V_L}{L_{OUT}}$$

where:

I_I = Inductor current

 L_{OUT} = Output inductance

V_L = V_{DDH} - V_{OUT} during high-side FET conduction and -VOLIT during low-side FET conduction.

Equation 9 shows that larger inductor values limit the regulator's ability to slew current through the output inductor in response to step-load transients. Consequently, more output capacitors are required to supply (or store) sufficient charge to maintain regulation while the inductor current ramps up to supply the load.

In contrast, smaller inductor values increase the regulator's maximum achievable slew rate and decrease the necessary capacitance, at the expense of higher ripple current. The peak-to-peak ripple current is given by Equation 10.

Equation 10:

$$I_{OUTRIPPLE} = \frac{t_{H_ON} \ x \left(V_{IN} - V_{OUT}\right)}{L_{OUT}}$$

where:

t_{H ON} = High-side switch on-time (based on nominal V_{OUT}) (see Equation 1)

L_{OUT} = Output inductance

V_{DDH} = Input voltage

V_{OUT} = Output voltage.

From Equation 10, for the same switching frequency, ripple current increases as L decreases. This increased ripple current results in increased AC losses, larger peak current, and for the same output capacitance, results in increased output voltage ripple.

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IOUTRIPPLE should be set to 25% to 50% of the IC's rated output current. A suitable inductor value can then be found by solving Equation 10 for inductance as in Equation 11 and Equation 12.

Equation 11:

$$L_{OUT} = \frac{V_{OUT} \times (V_{DDH} - V_{OUT})}{V_{DDH} \times I_{OUTRIPPLE} \times f_{SW}}$$

And assuming IOUTRIPPLE = 0.25 x IOUT for a typical inductor value (Equation 12).

Equation 12:

$$L_{OUT} = \frac{V_{OUT} \times (V_{DDH} - V_{OUT})}{V_{DDH} \times (0.25 \times I_{OUT}) \times f_{SW}}$$

So, for a 35A regulator running at 400kHz with V_{DDH} = 12V and V_{OUT} = 1V, Equation 13 shows the target value for the inductor.

Equation 13:

$$L_{OUT} = \frac{1 \times (12 - 1)}{12 \times 0.25 \times 35 \times 400000}$$
= 262nH

The saturation current rating of the inductor is another important consideration. At current limit, the peak inductor current is given Equation 14

Equation 14:

where:

I_{OCP} = Overcurrent-protection trip point (see the *Electrical* Characteristics table and the Current-Limiting and Short-Circuit Protection section).

IOUTRIPPLE = Peak-to-peak inductor current ripple, defined above

For proper OCP operation of the regulator, it is important that IPK never exceeds the saturation current rating of the inductor (I_{SAT}). It is recommended that a margin of at least 20% is included between IPK and ISAT, as shown in Equation 15.

Equation 15:

$$I_{SAT} > 1.2 \times I_{PK}$$

Also, note that during a hard V_{OUT} short circuit, IOUTRIPPLE increases due to VOUT going to zero in Equation 10.

Finally, the power dissipation of the inductor influences the regulation efficiency. Losses in the inductor include core loss, DC resistance loss, and AC resistance loss. For the best efficiency, use inductors with core material exhibiting low loss in the range of 0.5MHz to 2MHz and low-winding resistance.

Table 9 provides a summary of recommended inductor suppliers and part numbers.

Output Capacitor Selection

The minimum recommended output capacitance for stability is described in the Control-Loop Stability section and is normally implemented using several 100µF 1206 (or similar) MLCCs. For low slew-rate transient loads, RGAIN EFF determines the V_{OUT} FRROR for a given load step per the small-signal model, as discussed above. In this case, Cour has no effect on the Vour_ERROR-

However, in the event that the slew rate of the load transient greatly exceeds the slew rate of the inductor current, the transient V_{OUT} ERROR can be larger than predicted by the small-signal model. In this case, the V_{OUT} loading and unloading transients can be approximated by taking the larger result between Equation 7 and Equation 16.

Equation 16:

$$V_{SAG} = \frac{L_{OUT} \times \left(I_{STEP} + \frac{I_{OUTRIPPLE}}{2}\right)^{2}}{2 \times C_{OUT} \times \left(V_{DDH} - V_{OUT}\right)}$$

$$V_{SOAR} = \frac{L_{OUT} \times \left(I_{STEP} + \frac{I_{OUTRIPPLE}}{2}\right)^{2}}{2 \times C_{OUT} \times V_{OUT}} + I_{STEP} \times \frac{t_{H_ON}}{C_{OUT}}$$

where:

V_{SAG} = Loading transient

V_{SOAR} = Unloading transient.

In order to meet an aggressive transient specification, C_{OUT} may have to be increased and/or L_{OUT} decreased. However, note that decreasing LOUT results in larger inductor ripple current; thus, decreased efficiency and increased output voltage ripple.

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Output voltage ripple is another important consideration in the selection of output capacitors. For a buck regulator operating in CCM, the total voltage ripple across the output capacitor bank can be approximated as the sum of three voltage waveforms: 1) the triangle wave that results from multiplying the AC ripple current by the ESR, 2) the square wave that results from multiplying the ripple current slew rate by the ESL, and 3) the piecewise quadratic waveform that results from charging and discharging the output capacitor. In a typical MAX20743 application with a bank of 0805 X5R, 6.3V, 22µF output capacitors, these three voltage waveform components are roughly equal. Although the phasing of these three components impacts the total output voltage ripple, a common approximation is to ignore the phasing and to find the upper bound of the peak-to-peak ripple by summing all three components, as shown in Equation 17.

Equation 17:

$$\begin{aligned} V_{PP} = & \text{ESR}(I_{OUTRIPPLE}) + \text{ESL}\left(\frac{V_{DDH}}{L_{OUT}}\right) \\ & + \left(\frac{I_{OUTRIPPLE}}{8 \text{ x f}_{SW} \text{ x C}_{OUT}}\right) \end{aligned}$$

where:

ESR = Equivalent series resistance at the output

IOUTRIPPLE = Peak-to-peak inductor current ripple

ESL = High-frequency equivalent series inductance at output

V_{DDH} = Input voltage

LOUT = Output inductance

f_{SW} = Switching frequency

C_{OUT} = Output capacitance.

The ESL effect of an output capacitor on output voltage ripple cannot be easily estimated from the resonant frequency; the high-frequency (10MHz or above) impedance of that capacitor should be used instead. PCB traces and vias in the VOLIT/GND loop contribute additional parasitic inductance.

The final considerations in the selection of output capacitors are ripple-current rating and power dissipation. Using a conservative design approach, the output capacitors should be designed to handle the maximum peak-topeak AC ripple current experienced in the worst-case scenario. Because the recommended output capacitors have extremely low ESR values, they are typically rated well above the current and power stresses seen here.

For the triangular AC ripple current at the output, the total RMS current and power is given by Equation 18 and Equation 19.

Equation 18:

$$I_{RMS_COUT} = \frac{I_{OUTRIPPLE}}{\sqrt{12}}$$

where:

IOUTRIPPLE = Peak-to peak ripple current value.

Equation 19:

$$P_{COUT} = I_{RMS} COUT^2 \times ESR$$

where:

ESR = Equivalent series resistance of the entire output capacitor bank.

Input Capacitor Selection

The selection and placement of input capacitors are important considerations. High-frequency input capacitors serve to control switching noise. Bulk input capacitors are designed to filter the pulsed DC current that is drawn by the regulator. For the best performance, lowest cost and smallest size of the MAX20743 systems, MLCC capacitors with 1210 or smaller case sizes, capacitance values of 47µF or smaller, 16V or 25V voltage ratings, and X5R or better temperature characteristics are recommended as bulk. The minimum recommended value of capacitance is 2 x 47µF (bulk) and 1.0µF + 0.1µF (high frequency). Smaller values of bulk capacitance can be used in direct proportion to the maximum load current.

It is recommended to choose the main MLCC input capacitance to control the peak-to-peak input voltage ripple to 2% to 3% of its DC value in accordance with Equation 20.

Equation 20:

$$C_{IN} = \frac{I_{MAX} \times V_{OUT} \times (V_{DDH} - V_{OUT})}{(f_{SW} \times V_{DDH}^2 \times V_{INPP})}$$

where:

C_{IN} = Input capacitance (MLCC)

I_{MAX} = Maximum load current

V_{DDH} = DC input voltage

V_{OUT} = DC output voltage

f_{SW} = Switching frequency (CCM)

V_{DDHPP} = Target peak-to-peak input-voltage ripple.

Because the bulk input capacitors must source the pulsed DC input current of the regulator, the power dissipation, and ripple-current rating for these capacitors are far more important than that for the output capacitors. The RMS current that the input capacitor must withstand can be approximated using Equation 21.

Equation 21:

$$I_{RMS_CIN} = \frac{I_{LOAD} \sqrt{V_{OUT} x (V_{DDH} - V_{OUT})}}{V_{DDH}}$$

where:

 I_{LOAD} = Output DC load current.

With an equivalent series resistance of the bulk input capacitor bank (ESR_{CIN}), the total power dissipation in the input capacitors is given by Equation 22.

Equation 22:

$$P_{CIN} = I_{RMS} CIN^2 \times ESR_{CIN}$$

Resistor Selection and its Effect on DC Output-Voltage Accuracy

 R_{FB1} and R_{FB2} set the output voltage, as described in Equation 4. The tolerance of these resistors affects the

accuracy of the set output voltage. Due to the form of Equation 4, the effect is higher at higher output voltages.

<u>Figure 5</u> shows the effect of 0.1% tolerance resistors over a range of output voltages. For different tolerance resistors, multiply the output voltage error by the resistors' tolerances divided by 0.1%. For example, for 0.5% tolerance resistors, multiply the output error shown by 5. To obtain accuracy over temperature, for a worst-case scenario, the temperature coefficients multiplied by the temperature range should be added to the tolerance (i.e., for 25ppm/°C resistors over a 50°C excursion, add 0.125% to the 25°C tolerance).

The error due to the voltage-feedback resistors' tolerance (R_{FB1} and R_{FB2}) should be added to the output voltage tolerance due to the IC's feedback-voltage accuracy shown in the *Electrical Characteristics* table.

Voltage Margining

Voltage margining can be achieved by changing the V_{OUT} setting through PMBus. V_{OUT} changes occur with a default linear slew rate of 1V/ms. The slew rate can be set to 1, 2, or 4mV/ μ s using the V_{RATE} bits. See AN6042: MAX20743 PMBus Application Note for details. If a voltage-divider is present in the feedback loop, the V_{OUT} slew rate is scaled accordingly.

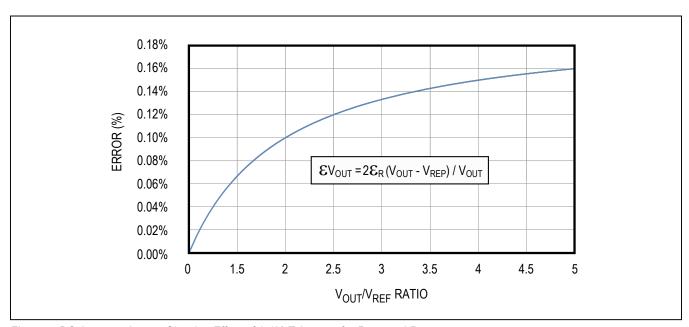


Figure 5. DC Accuracy Impact Showing Effect of 0.1% Tolerance for R_{FB1} and R_{FB2}

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PCB Layout

PCB layout can dramatically affect the performance of the regulator. A poorly designed board can degrade efficiency, noise performance, and even control-loop stability. At higher switching frequencies, layout issues are especially critical.

As a general guideline, the input capacitors and the output inductor should be placed in close proximity to the regulator IC, while the output capacitors should be lumped together as close as possible to the load. Traces to these components should be kept as short and wide as possible to minimize parasitic inductance and resistance. Traces connecting the input capacitors and V_{DDH} (power input node) on the IC require particular attention since they carry currents with the largest RMS values and fastest slew rates. According to best practice, the input capacitors should be placed as close as possible to the input supply pins, with the smallest package high-frequency capacitor being the closest to the IC and no more than 60 mils from the IC pins. Preferably, there should be an uninterrupted ground plane located immediately underneath these high-frequency current paths, with the ground plane located no more than 8 mils below the top layer. By keeping the flow of this highfrequency AC current localized to a tight loop at the regulator, electromagnetic interference (EMI) can be minimized.

Voltage-sense lines should be routed differentially directly from the load points. The ground plane can be used as a shield for these or other sensitive signals to protect them from capacitive or magnetic coupling of high-frequency noise.

For remote-sense applications where the load and regulator IC are separated by a significant distance or impedance, it is important to place the majority of the output capacitors directly at the load. Ideally, for system stability, all of the output capacitors should be placed as close as possible to the load. In remote-sense applications, common-mode filtering is necessary to filter high-frequency noise in the sense lines.

The following layout recommendations should be used for optimal performance:

- It is essential to have a low-impedance and uninterrupted ground plane under the IC and extended out underneath the inductor and output capacitor bank.
- Multiple vias are recommended for all paths that carry high currents (i.e., GND, V_{DDH}, VX). Vias should be placed close to the chip to create the shortest possible current loops. Via placement must not obstruct the flow of currents or mirror currents in the ground plane.
- A single via in close proximity to the chip should be used to tie the top layer A_{GND} trace to the second layer ground plane, it must not be connected to the top power ground area.
- The feedback-divider and compensation network should be close to the IC to minimize the noise on the IC side of the divider.

Gerber files with layout information and complete reference designs can be obtained by contacting a Maxim account representative.

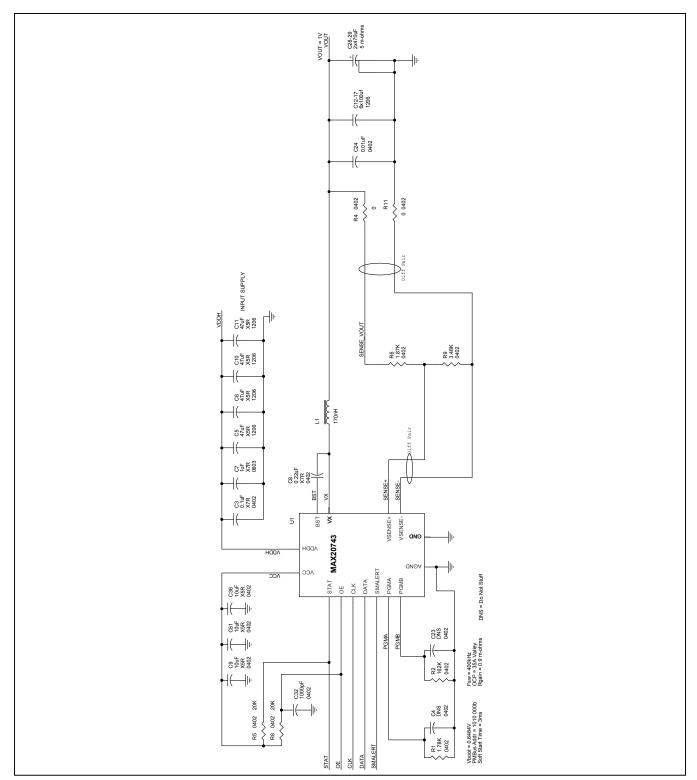


Figure 6. MAX20743 Reference Schematic ($V_{OUT} = 1V$, $V_{DDH} = 4.5V$ to 16V)

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX20743EPL+	-40°C to +125°C	15 FCQFN
MAX20743EPL+T	-40°C to +125°C	15 FCQFN

⁺Denotes a lead(Pb)-free/RoHS-compliant package. T = Tape and reel.

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	6/16	Initial release	_
1	10/16	Updated the <i>Typical Operating Characteristics</i> , and <i>Absolute Maximum Ratings</i> sections; Added the <i>Input Current Limit</i> section and updated numbering for Equations 3-22.	1–7, 9–10, 18–19, 22–27

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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